6A595

Data Sheet **26185.121**

ADVANCE INFORMATION

March 22, 2000

A6A595KA (DIP) OUT₁ OUT₂ OUT₃ OUT₀ LATCHES SERIAL REGISTER CLR REGISTER 18 CLEAR OUTPUT LOGIC OE 17 **ENABLE** SUPPLY **POWER** POWER 16 GROUND GROUND **POWER POWER** GROUND GROUND LOGIC STROBE GROUND SERIAL CLOCK CLK 13 DATA OUT REGISTER 12 OUT₇ LATCHES OUT₅ 10 OUT₆ 11

Dwa. PP-029-1

ABSOLUTE MAXIMUM RATINGS at $T_{\Delta} = 25^{\circ}C$

Output Voltage, V _O 50 V
Output Drain Current,
Continuous, I _O 350 mA*
Peak, I _{OM} 1100 mA†
Single-Pulse Avalanche Energy,
E _{AS} 75 mJ
Logic Supply Voltage, V_{DD} 7.0 V
Input Voltage Range,
V_{I} 0.3 V to +7.0 V
V_1
-
Package Power Dissipation,
Package Power Dissipation, PD See Graph
Package Power Dissipation, PD See Graph Operating Temperature Range,
Package Power Dissipation, P_D See Graph Operating Temperature Range, T_A 40°C to +125°C

Caution: These CMOS devices have input static protection (Class 3) but are still susceptible to damage if exposed to extremely high static electrical charges.

† Pulse duration $\leq 100 \,\mu s$, duty cycle $\leq 2\%$.

8-BIT SERIAL-INPUT, **DMOS POWER DRIVER**

The A6A595KA and A6A595KLB combine an 8-bit CMOS shift register and accompanying data latches, control circuitry, and DMOS power driver outputs. Power driver applications include relays, solenoids, and other medium-current or high-voltage peripheral power loads.

The serial-data input, CMOS shift register and latches allow direct interfacing with microprocessor-based systems. Serial-data input rates are over 5 MHz. Use with TTL may require appropriate pull-up resistors to ensure an input logic high.

A CMOS serial-data output enables cascade connections in applications requiring additional drive lines.

The A6A595 DMOS open-drain outputs are capable of sinking up to 500 mA. All of the output drivers are disabled (the DMOS sink drivers turned off) by the OUTPUT ENABLE input high.

The A6A595KA is furnished in a 20-pin dual in-line plastic package. The A6A595KLB is furnished in a 24-lead wide-body, smalloutline plastic batwing package (SOIC) with gull-wing leads. Copper lead frames, reduced supply current requirements, and low on-state resistance allow both devices to sink 150 mA from all outputs continuously, to ambient temperatures over 85°C.

FEATURES

- 50 V Minimum Output Clamp Voltage
- 350 mA Output Current (all outputs simultaneously)
- Internal Short-Circuit Protection

 Low Power Content

 Low Power Con
- Replacements for TPIC6A595N and TPIC6A595DW

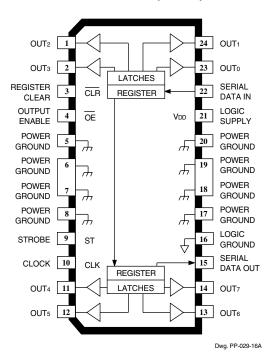
Always order by complete part number:

Part Number	Package	$R_{\theta JA}$	$R_{\theta JC}$	$R_{\theta JT}$
A6A595KA	20-pin DIP	55°C/W	25°C/W	_
A6A595KLB	24-lead SOIC	55°C/W	_	6°C/W

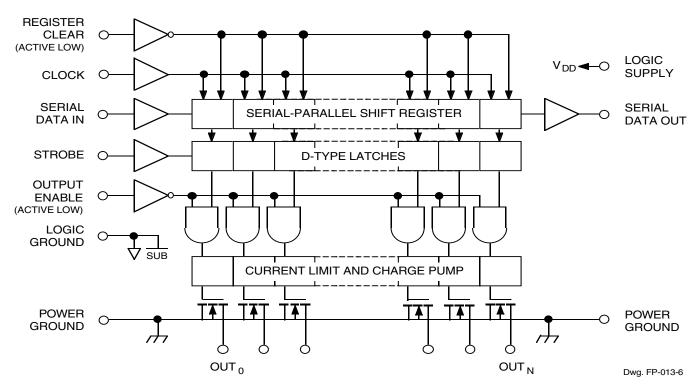


SUFFIX 'LB', R _{0JT} = 6.0°C/W 3 SUFFIX 'A', R _{0JC} = 25°C/W 2 1 R _{0JA} = 55°C/W 1 25 50 75 100 125 150 TEMPERATURE IN °C

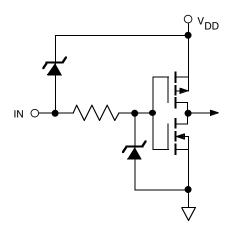
A6A595KLB (SOIC)



FUNCTIONAL BLOCK DIAGRAM



Power grounds must be connected together externally.



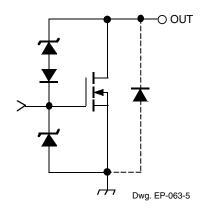
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LOGIC INPUTS

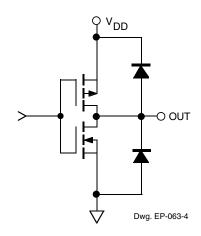
RECOMMENDED OPERATING CONDITIONS

over operating temperature range

Logic Supply Voltage Range, V _{DD}	4.5 V to 5.5 V
High-Level Input Voltage, V _{IH}	$\geq 0.85V_{DD}$
Low-level input voltage, V _{IL}	≤0.15V _{DD}



DMOS POWER DRIVER OUTPUT



SERIAL DATA OUT

TRUTH TABLE

Data	Clock	SI	nift F	Regis	ter C	onte	nts	Serial Data		Latch Contents						Output		Output Contents				
Input	Input	I ₀	l ₁	l ₂		I ₆	l ₇	Output	Strobe	I ₀	l ₁	l ₂		l ₆	l ₇	Enable	l ₀	l ₁	l ₂		I ₆	l ₇
Н	7	Н	R_0	R ₁		R ₅	R_6	R ₆														
L	7	L	R ₀	R ₁		R ₅	R ₆	R ₆														
Х	_	R ₀	R ₁	R ₂		R ₆	R ₇	R ₇														
		Х	Х	Χ		Х	Χ	Х		R ₀	R ₁	R ₂		R_6	R ₇							
		P ₀	P ₁	P ₂		P ₆	P ₇	P ₇	Ч	P ₀	P ₁	P ₂		P ₆	P ₇	L	P ₀	P ₁	P ₂		P ₆	P ₇
										Х	Х	Х		Х	Х	Н	Н	Н	Н		Н	Н

L = Low Logic Level H = High Logic Level X = Irrelevant P = Present State R = Previous State

ELECTRICAL CHARACTERISTICS at T_A = +25°C, V_{DD} = 5 V, t_{ir} = $t_{if} \le$ 10 ns (unless otherwise specified).

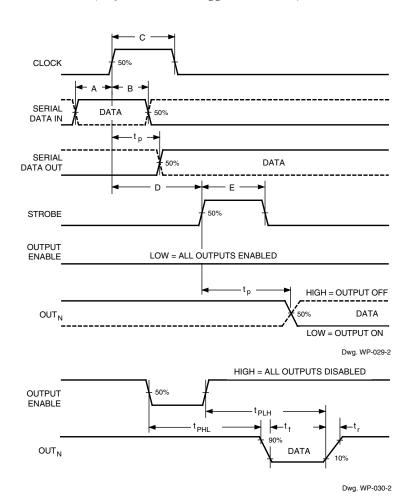
			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Breakdown Voltage	V _{(BR)DSX}	I _O = 1 mA	50	_	_	V
Off-State Output	I _{DSX}	V _O = 40 V	_	0.1	1.0	μА
Current		V _O = 40 V, T _A = 125°C	_	0.2	5.0	μА
Static Drain-Source	r _{DS(on)}	I _O = 350 mA	_	1.0	1.5	Ω
On-State Resistance		I _O = 350 mA, T _A = 125°C	_	1.7	2.5	Ω
Source-to-Drain Diode Voltage	V _{SD}	I _F = 350 mA	_	1.0	_	V
Nominal Output Current	I _{O(nom)}	V _{DS(on)} = 0.5 V, T _A = 85°C	_	350	—	mA
Output Current	I _{O(chop)}	I_O at which chopping starts, $T_C = 25^{\circ}C$	0.6	0.8	1.1	А
Logic Input Current	I _{IH}	$V_{I} = V_{DD}$	_	_	1.0	μΑ
	I _{IL}	V _I = 0	_	_	-1.0	μΑ
SERIAL-DATA	V _{OH}	I _{OH} = -20 μA	4.9	4.99	_	V
Output Voltage		I _{OH} = -4 mA	4.5	4.7	_	V
	V _{OL}	I _{OL} = 20 μA		0	0.1	V
		I _{OL} = 4 mA		0.3	0.5	V
Prop. Delay Time	t _{PLH}	I _O = 350 mA, C _L = 30 pF	_	100	_	ns
	t _{PHL}	I _O = 350 mA, C _L = 30 pF		60		ns
Output Rise Time	t _r	I _O = 350 mA, C _L = 30 pF	_	55	_	ns
Output Fall Time	t _f	I _O = 350 mA, C _L = 30 pF	_	40	_	ns
Supply Current	I _{DD(off)}	Outputs OFF	_	0.5	5.0	mA
	I _{DD(fclk)}	$f_{clk} = 5 \text{ MHz}, C_L = 30 \text{ pF}, \text{ Outputs OFF}$	_	_	1.3	mA

Typical Data is at $V_{DD} = 5 \text{ V}$ and is for design information only.

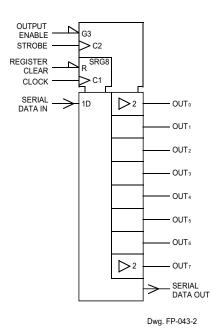
NOTE — Pulse test, duration $\leq 100 \,\mu s$, duty cycle $\leq 2\%$.

TIMING REQUIREMENTS and SPECIFICATIONS

(Logic Levels are V_{DD} and Ground)



LOGIC SYMBOL



(Data Set-Up Time), t _{su(D)}	20 ns
B. Data Active Time After Clock Pulse	
(Data Hold Time), t _{h(D)}	20 ns
C. Clock Pulse Width, t _{w(CLK)}	
D. Time Between Clock Activation	
and Strobe, t _{su(ST)}	50 ns
E. Strobe Pulse Width, t _{w(ST)}	50 ns
F. Output Enable Pulse Width, $t_{w(OE)}$	4.5 μs
NOTE – Timing is representative of a 12.5 MHz clock.	

A. Data Active Time Before Clock Pulse

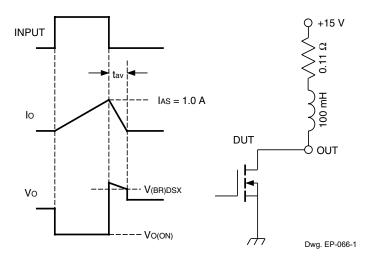
Higher speeds are attainable.

Serial data present at the input is transferred to the shift register on the rising edge of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT.

Information present at any register is transferred to the respective latch on the rising edge of the STROBE input pulse (serial-to-parallel conversion).

When the OUTPUT ENABLE input is high, the output source drivers are disabled (OFF). The information stored in the latches is not affected by the OUTPUT ENABLE input. With the OUTPUT ENABLE input low, the outputs are controlled by the state of their respective latches.

TEST CIRCUITS



 $E_{AS} = I_{AS} \times V_{(BR)DSX} \times t_{AV}/2$

Single-Pulse Avalanche Energy Test Circuit and Waveforms

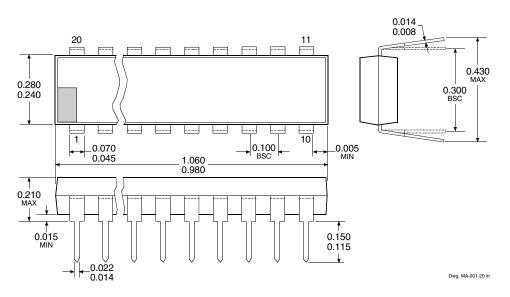
TERMINAL DESCRIPTIONS

A6A595KA (DIP)	A6A595KLB (SOIC)	Tamain al Nonce	Firm att an
Terminal No.	Terminal No.	Terminal Name	Function
1-2	1-2	OUT ₂₋₃	Current-sinking, open-drain DMOS output terminals.
3	3	REGISTER CLEAR	When (active) low, the registers are cleared (set low).
4	4	OUTPUT ENABLE	When (active) low, the output drivers are enabled; when high, all output drivers are turned OFF (blanked).
5-6	5-8	POWER GROUND	Reference terminal for output voltage measurements.
7	9	STROBE	Data strobe input terminal; shift register data is latched on rising edge.
8	10	CLOCK	Clock input terminal for data shift on rising edge.
9-12	11-14	OUT ₄₋₇	Current-sinking, open-drain DMOS output terminals.
13	15	SERIAL DATA OUT	CMOS serial-data output to the following shift register.
14	16	LOGIC GROUND	Reference terminal for input voltage measurements.
15-16	17-20	POWER GROUND	Reference terminal for output voltage measurements.
17	21	LOGIC SUPPLY	(V _{DD}) The logic supply voltage (typically 5 V).
18	22	SERIAL DATA IN	Serial-data input to the shift-register.
19-20	23-24	OUT ₀₋₁	Current-sinking, open-drain DMOS output terminals.

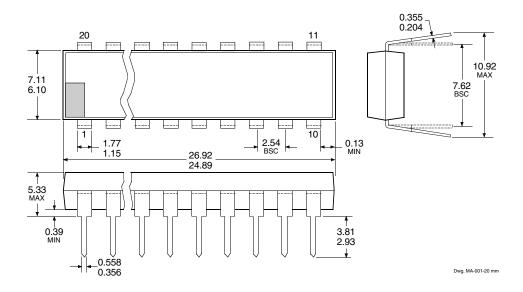
NOTE —Power grounds must be connected together externally.

A6A595KA

Dimensions in Inches (controlling dimensions)



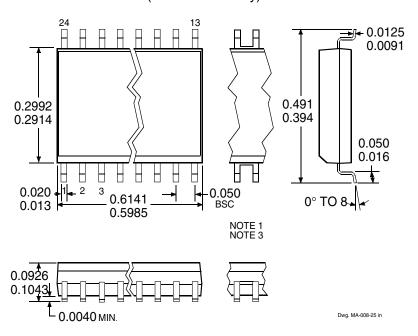
Dimensions in Millimeters (for reference only)



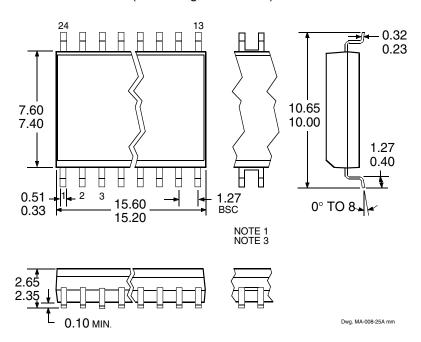
- NOTES:1. Exact body and lead configuration at vendor's option within limits shown.
 - 2. Lead spacing tolerance is non-cumulative
 - 3. Lead thickness is measured at seating plane or below.

A6A595KLB

Dimensions in Inches (for reference only)



Dimensions in Millimeters (controlling dimensions)



- NOTES: 1. Webbed lead frame. Leads 6, 7, 18, and 19 are internally one piece.
 - 2. Lead spacing tolerance is non-cumulative.
 - 3. Exact body and lead configuration at vendor's option within limits shown.

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